



Features

- Compliant with AEC-Q200 Rev-C- Stress Test Qualification for Passive Components in Automotive Applications
- 100 % electrically compatible with all previous generations of 1812 SMT devices
- Compatible with Pb and Pb-free solder reflow profiles
- RoHS compliant* and halogen free**
- Surface mount packaging for automated assembly
- Agency recognition:   
- Standard 4532 mm (1812 mils) footprint
- Patents pending

MF-MSMF Series - PTC Resettable Fuses

Electrical Characteristics

Model	V max. Volts	I max. Amps	I _{hold}	I _{trip}	Resistance		Max. Time To Trip		Tripped Power Dissipation
			Amperes at 23 °C		Ohms at 23 °C		Amperes at 23 °C	Seconds at 23 °C	Watts at 23 °C
			Hold	Trip	R _{Min.}	R _{1Max.}			Typ.
MF-MSMF010	60.0	40	0.10	0.30	0.70	15.00	0.5	1.50	0.8
MF-MSMF014	60.0	40	0.14	0.34	0.40	6.50	1.5	0.15	0.8
MF-MSMF020	30.0	80	0.20	0.40	0.40	6.00	6.0	0.06	0.8
MF-MSMF020/60	60.0	40	0.20	0.40	0.40	6.00	1.5	0.15	0.8
MF-MSMF030	30.0	10	0.30	0.60	0.30	3.00	8.0	0.10	0.8
MF-MSMF050	15.0	100	0.50	1.00	0.15	1.00	8.0	0.15	0.8
MF-MSMF075	13.2	100	0.75	1.50	0.11	0.45	8.0	0.20	0.8
MF-MSMF075/24	24.0	40	0.75	1.50	0.11	0.45	8.0	0.20	0.8
MF-MSMF110	6.0	100	1.10	2.20	0.04	0.21	8.0	0.30	0.8
MF-MSMF110/16	16.0	100	1.10	2.20	0.04	0.21	8.0	0.30	0.8
MF-MSMF110/24X	24.0	20	1.10	2.20	0.06	0.18	8.0	0.50	0.8
MF-MSMF125	6.0	100	1.25	2.50	0.035	0.14	8.0	0.40	0.8
MF-MSMF150	6.0	100	1.50	3.00	0.03	0.120	8.0	0.5	0.8
MF-MSMF150/24X	24.0	20	1.50	3.00	0.03	0.120	8.0	1.50	1.0
MF-MSMF160	8.0	100	1.60	2.80	0.035	0.099	8.0	2.0	0.8
MF-MSMF200	8.0	40	2.00	4.00	0.020	0.080	8.0	3.0	0.8
MF-MSMF250/16X	16.0	100	2.50	5.00	0.015	0.100	8.0	5.0	1.2
MF-MSMF260	6.0	100	2.60	5.20	0.015	0.080	8.0	5.0	0.8

Environmental Characteristics

Operating Temperature.....	-40 °C to +85 °C
Maximum Device Surface Temperature in Tripped State	125 °C
Passive Aging	+85 °C, 1000 hours..... ±5 % typical resistance change
Humidity Aging	+85 °C, 85 % R.H. 1000 hours..... ±5 % typical resistance change
Thermal Shock	+85 °C to -40 °C, 20 times..... ±10 % typical resistance change
Solvent Resistance.....	MIL-STD-202, Method 215..... No change
Vibration	MIL-STD-883C, Method 2007.1, Condition A..... No change

Test Procedures And Requirements For Model MF-MSMF Series

Test	Test Conditions	Accept/Reject Criteria
Visual/Mech.....	Verify dimensions and materials.....	Per MF physical description
Resistance.....	In still air @ 23 °C.....	R _{min} ≤ R ≤ R _{1max}
Time to Trip.....	At specified current, V _{max} , 23 °C	T ≤ max. time to trip (seconds)
Hold Current.....	30 min. at I _{hold}	No trip
Trip Cycle Life.....	V _{max} , I _{max} , 100 cycles.....	No arcing or burning
Trip Endurance	V _{max} , 48 hours.....	No arcing or burning
Solderability.....	ANSI/J-STD-002.....	95 % min. coverage
UL File Number	E174545 http://www.ul.com/ Follow link to Certifications, then UL File No., enter E174545	
CSA File Number	CA110338 http://directories.csa-international.org/ Under "Certification Record" and "File Number" enter 110338-0-000	
TÜV Certificate Number	R 02057213 http://www.tuvdotcom.com/ Follow link to "other certificates", enter File No. 2057213	

*RoHS Directive 2002/95/EC Jan 27 2003 including Annex.

**To be considered halogen free, each homogenous material can have a maximum concentration of 900 ppm of either bromine or chlorine.

Specifications are subject to change without notice.

Customers should verify actual device performance in their specific applications.

Applications

- Overcurrent and overtemperature protection of automotive electronics
- Hard disk drives
- PC motherboards
- PC peripherals
- Point-of-sale (POS) equipment
- PCMCIA cards
- USB port protection - USB 2.0, 3.0 & OTG
- HDMI 1.4 Source protection

MF-MSMF Series - PTC Resettable Fuses

BOURNS®

Product Dimensions (see next page for outline drawings)

Model	A		B		C		D	Style
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	
MF-MSMF010	$\frac{4.37}{(0.172)}$	$\frac{4.73}{(0.186)}$	$\frac{3.07}{(0.121)}$	$\frac{3.41}{(0.134)}$	$\frac{0.70}{(0.028)}$	$\frac{1.10}{(0.043)}$	$\frac{0.30}{(0.012)}$	1
MF-MSMF014	$\frac{4.37}{(0.172)}$	$\frac{4.73}{(0.186)}$	$\frac{3.07}{(0.121)}$	$\frac{3.41}{(0.134)}$	$\frac{0.70}{(0.028)}$	$\frac{1.10}{(0.043)}$	$\frac{0.30}{(0.012)}$	1
MF-MSMF020	$\frac{4.37}{(0.172)}$	$\frac{4.73}{(0.186)}$	$\frac{3.07}{(0.121)}$	$\frac{3.41}{(0.134)}$	$\frac{0.70}{(0.028)}$	$\frac{1.10}{(0.043)}$	$\frac{0.30}{(0.012)}$	1
MF-MSMF020/60	$\frac{4.37}{(0.172)}$	$\frac{4.73}{(0.186)}$	$\frac{3.07}{(0.121)}$	$\frac{3.41}{(0.134)}$	$\frac{0.70}{(0.028)}$	$\frac{1.10}{(0.043)}$	$\frac{0.30}{(0.012)}$	1
MF-MSMF030	$\frac{4.37}{(0.172)}$	$\frac{4.73}{(0.186)}$	$\frac{3.07}{(0.121)}$	$\frac{3.41}{(0.134)}$	$\frac{0.70}{(0.028)}$	$\frac{1.10}{(0.043)}$	$\frac{0.30}{(0.012)}$	1
MF-MSMF050	$\frac{4.37}{(0.172)}$	$\frac{4.73}{(0.186)}$	$\frac{3.07}{(0.121)}$	$\frac{3.41}{(0.134)}$	$\frac{0.55}{(0.015)}$	$\frac{0.85}{(0.033)}$	$\frac{0.30}{(0.012)}$	1
MF-MSMF075	$\frac{4.37}{(0.172)}$	$\frac{4.73}{(0.186)}$	$\frac{3.07}{(0.121)}$	$\frac{3.41}{(0.134)}$	$\frac{0.55}{(0.015)}$	$\frac{0.85}{(0.033)}$	$\frac{0.30}{(0.012)}$	1
MF-MSMF075/24	$\frac{4.37}{(0.172)}$	$\frac{4.73}{(0.186)}$	$\frac{3.07}{(0.121)}$	$\frac{3.41}{(0.134)}$	$\frac{0.55}{(0.015)}$	$\frac{0.85}{(0.033)}$	$\frac{0.30}{(0.012)}$	1
MF-MSMF110	$\frac{4.37}{(0.172)}$	$\frac{4.73}{(0.186)}$	$\frac{3.07}{(0.121)}$	$\frac{3.41}{(0.134)}$	$\frac{0.45}{(0.018)}$	$\frac{0.85}{(0.033)}$	$\frac{0.30}{(0.012)}$	1
MF-MSMF110/16	$\frac{4.37}{(0.172)}$	$\frac{4.73}{(0.186)}$	$\frac{3.07}{(0.121)}$	$\frac{3.41}{(0.134)}$	$\frac{0.45}{(0.018)}$	$\frac{0.85}{(0.033)}$	$\frac{0.30}{(0.012)}$	1
MF-MSMF110/24X	$\frac{4.37}{(0.172)}$	$\frac{4.83}{(0.190)}$	$\frac{3.07}{(0.121)}$	$\frac{3.41}{(0.134)}$	$\frac{0.70}{(0.028)}$	$\frac{1.60}{(0.063)}$	$\frac{0.30}{(0.012)}$	2
MF-MSMF125	$\frac{4.37}{(0.172)}$	$\frac{4.73}{(0.186)}$	$\frac{3.07}{(0.121)}$	$\frac{3.41}{(0.134)}$	$\frac{0.55}{(0.015)}$	$\frac{0.85}{(0.033)}$	$\frac{0.30}{(0.012)}$	1
MF-MSMF150	$\frac{4.37}{(0.172)}$	$\frac{4.73}{(0.186)}$	$\frac{3.07}{(0.121)}$	$\frac{3.41}{(0.134)}$	$\frac{0.55}{(0.015)}$	$\frac{0.85}{(0.033)}$	$\frac{0.30}{(0.012)}$	1
MF-MSMF150/24X	$\frac{4.37}{(0.172)}$	$\frac{4.83}{(0.190)}$	$\frac{3.07}{(0.121)}$	$\frac{3.41}{(0.134)}$	$\frac{0.70}{(0.028)}$	$\frac{1.60}{(0.063)}$	$\frac{0.30}{(0.012)}$	2
MF-MSMF160	$\frac{4.37}{(0.172)}$	$\frac{4.73}{(0.186)}$	$\frac{3.07}{(0.121)}$	$\frac{3.41}{(0.134)}$	$\frac{0.55}{(0.015)}$	$\frac{0.85}{(0.033)}$	$\frac{0.30}{(0.012)}$	1
MF-MSMF200	$\frac{4.37}{(0.172)}$	$\frac{4.73}{(0.186)}$	$\frac{3.07}{(0.121)}$	$\frac{3.41}{(0.134)}$	$\frac{0.55}{(0.015)}$	$\frac{0.85}{(0.033)}$	$\frac{0.30}{(0.012)}$	1
MF-MSMF250/16X	$\frac{4.37}{(0.172)}$	$\frac{4.83}{(0.190)}$	$\frac{3.07}{(0.121)}$	$\frac{3.41}{(0.134)}$	$\frac{0.70}{(0.028)}$	$\frac{1.60}{(0.063)}$	$\frac{0.30}{(0.012)}$	2
MF-MSMF260	$\frac{4.37}{(0.172)}$	$\frac{4.73}{(0.186)}$	$\frac{3.07}{(0.121)}$	$\frac{3.41}{(0.134)}$	$\frac{0.48}{(0.019)}$	$\frac{0.85}{(0.033)}$	$\frac{0.30}{(0.012)}$	1

Packaging:

MF-MSMF010 through MF-MSMF030 = 1500 pcs. per reel.
 MF-MSMF050 through MF-MSMF200 & MF-MSMF260 = 2000 pcs. per reel.
 MF-MSMF110/24X = 1000 pcs. per reel.
 MF-MSMF150/24X & MF-MSMF250/16X = 1500 pcs. per reel.

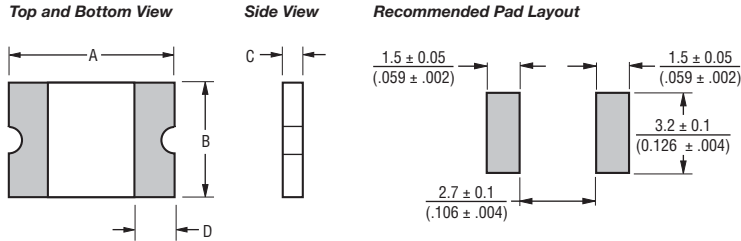
DIMENSIONS: $\frac{\text{MM}}{(\text{INCHES})}$

MF-MSMF Series - PTC Resettable Fuses

BOURNS®

Product Dimensions (see previous page for dimensions)

Style 1



Terminal material:

Electroless Ni under immersion Au

Termination pad solderability:

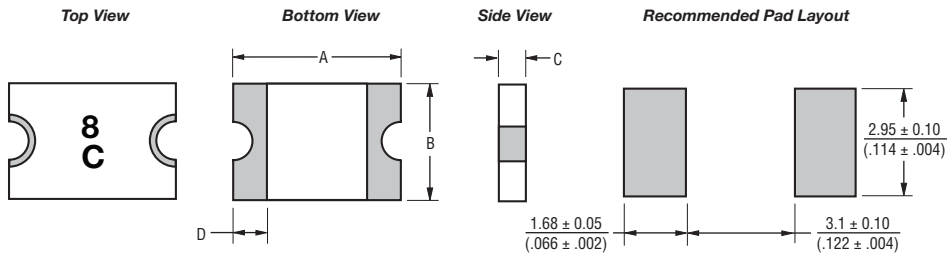
Standard Au finish:

Meets ANSI/J-STD-002 Category 2.

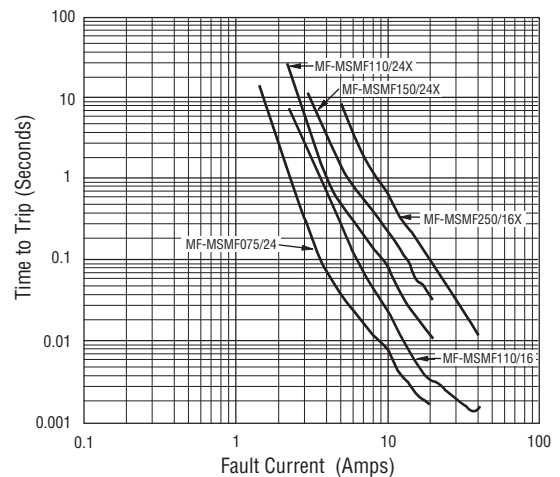
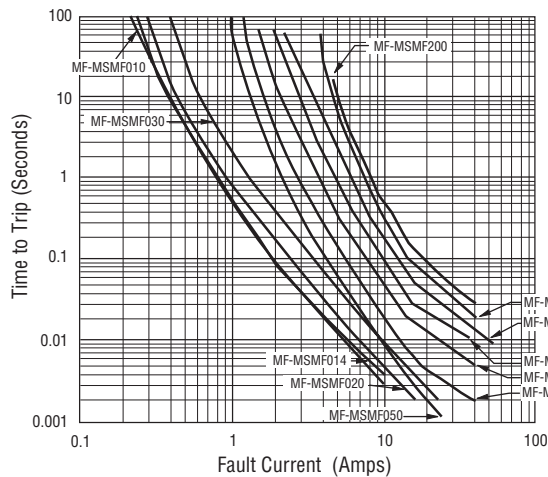
Recommended Storage:

40 °C max./70 % RH max.

Style 2



Typical Time to Trip at 23 °C



The Time to Trip curves represent typical performance of a device in a simulated application environment. Actual performance in specific customer applications may differ from these values due to the influence of other variables.

Specifications are subject to change without notice.

Customers should verify actual device performance in their specific applications.

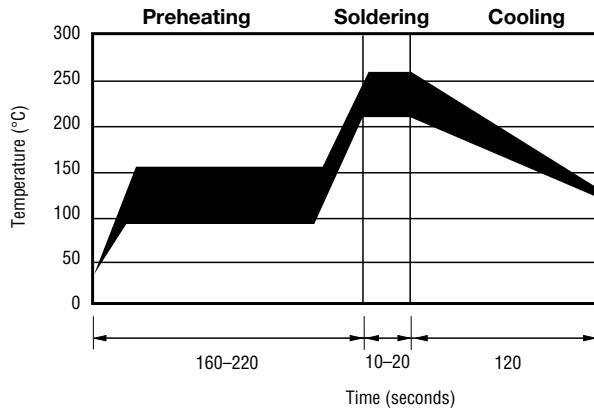
MF-MSMF Series - PTC Resettable Fuses

BOURNS®

Thermal Derating Chart - I_{hold} (Amps)

Model	Ambient Operating Temperature								
	-40 °C	-20 °C	0 °C	23 °C	40 °C	50 °C	60 °C	70 °C	85 °C
MF-MSMF010	0.16	0.14	0.12	0.10	0.08	0.07	0.06	0.05	0.03
MF-MSMF014	0.23	0.19	0.17	0.14	0.12	0.10	0.09	0.08	0.06
MF-MSMF020	0.29	0.26	0.23	0.20	0.17	0.15	0.14	0.12	0.10
MF-MSMF020/60	0.29	0.26	0.23	0.20	0.17	0.15	0.14	0.12	0.10
MF-MSMF030	0.44	0.39	0.35	0.30	0.26	0.23	0.21	0.18	0.15
MF-MSMF050	0.77	0.68	0.59	0.50	0.44	0.40	0.37	0.33	0.29
MF-MSMF075	1.15	1.01	0.88	0.75	0.65	0.60	0.55	0.49	0.43
MF-MSMF075/24	1.15	1.01	0.88	0.75	0.65	0.60	0.55	0.49	0.43
MF-MSMF110	1.59	1.43	1.26	1.10	0.95	0.87	0.80	0.71	0.60
MF-MSMF110/16	1.59	1.43	1.26	1.10	0.95	0.87	0.80	0.71	0.60
MF-MSMF110/24X	2.00	1.70	1.40	1.10	0.95	0.88	0.80	0.73	0.61
MF-MSMF125	1.80	1.63	1.43	1.25	1.08	0.99	0.91	0.81	0.68
MF-MSMF150	2.17	1.95	1.72	1.50	1.30	1.18	1.09	0.97	0.82
MF-MSMF150/24X	2.10	1.90	1.70	1.50	1.25	1.13	1.00	0.88	0.69
MF-MSMF160	2.30	2.20	1.90	1.60	1.45	1.30	1.15	1.03	0.91
MF-MSMF200	3.08	2.71	2.35	2.00	1.80	1.60	1.50	1.40	1.25
MF-MSMF250/16X	3.85	3.45	3.00	2.50	2.05	1.85	1.75	1.30	1.10
MF-MSMF260	4.00	3.52	3.06	2.60	2.34	2.08	1.95	1.39	1.04

Solder Reflow Recommendations



Notes:

- MF-MSMF models cannot be wave soldered. Please contact Bourns for hand soldering recommendations.
- If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.
- Compatible with Pb and Pb-free solder reflow profiles.
- Excess solder may cause a short circuit, especially during hand soldering. Please refer to the Multifuse® Polymer PTC Soldering Recommendation guidelines.

How to Order

MF - MSMF 075/24 - 2

Multifuse® Product Designator

Series
MSMF = 4532 mm (1812 mils)
Surface Mount Component

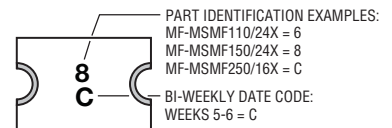
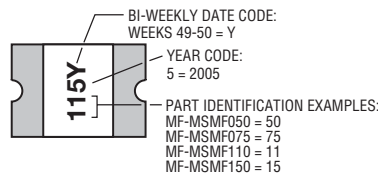
Hold Current, I_{hold}
010-260 (0.10 Amps - 2.60 Amps)

Higher Voltage Option
= Standard Voltage
/16 = 16 Volt Rated
/24 = 24 Volt Rated
/60 = 60 Volt Rated
X = Multifuse® freeXpansion Design™
MF-MSMF Series

Packaging
Packaged per EIA 481-1
-2 = Tape and Reel

Typical Part Marking

Represents total content. Layout may vary.



MF-MSMF SERIES, REV. AB, 12/10

"freeXpansion Design" is a trademark of Bourns, Inc.
Specifications are subject to change without notice.

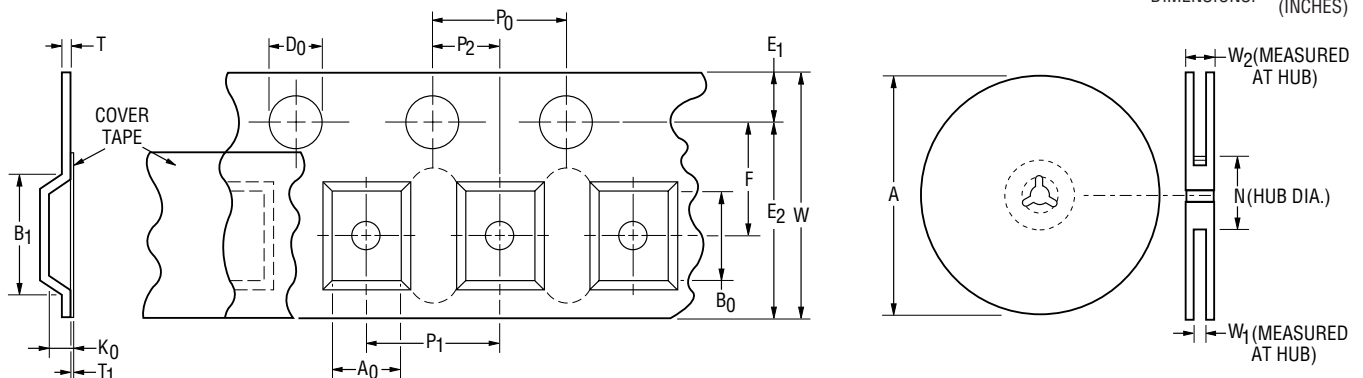
Customers should verify actual device performance in their specific applications.

MF-MSMF Series Tape and Reel Specifications

BOURNS®

Tape Dimensions	MF-MSMF010 - MF-MSMF030 per EIA-481-1	MF-MSMF050 - MF-MSMF260 per EIA 481-1	MF-MSMF-110/24X MF-MSMF150/24X MF-MSMF250/16X per EIA 481-1
W	12.0 ± 0.30 (0.472 ± 0.012)	12.0 ± 0.30 (0.472 ± 0.012)	12.0 ± 0.30 (0.472 ± 0.012)
P ₀	4.0 ± 0.10 (0.157 ± 0.004)	4.0 ± 0.10 (0.157 ± 0.004)	4.0 ± 0.10 (0.157 ± 0.004)
P ₁	8.0 ± 0.10 (0.315 ± 0.004)	8.0 ± 0.10 (0.315 ± 0.004)	8.0 ± 0.10 (0.315 ± 0.004)
P ₂	2.0 ± 0.05 (0.079 ± 0.002)	2.0 ± 0.05 (0.079 ± 0.002)	2.0 ± 0.05 (0.079 ± 0.002)
A ₀	3.58 ± 0.10 (0.141 ± 0.004)	3.66 ± 0.15 (0.144 ± 0.006)	3.70 ± 0.10 (0.146 ± 0.004)
B ₀	4.93 ± 0.10 (0.194 ± 0.004)	4.98 ± 0.10 (0.196 ± 0.004)	5.10 ± 0.10 (0.200 ± 0.004)
B ₁ max.	5.9 (0.232)	5.9 (0.232)	5.9 (0.232)
D ₀	$1.5 + 0.10/-0.0$ (0.059 + 0.004/-0)	$1.5 + 0.10/-0.0$ (0.059 + 0.004/-0)	$1.5 + 0.10/-0.0$ (0.059 + 0.004/-0)
F	5.5 ± 0.05 (0.217 ± 0.002)	5.5 ± 0.05 (0.217 ± 0.002)	5.5 ± 0.05 (0.217 ± 0.002)
E ₁	1.75 ± 0.10 (0.069 ± 0.004)	1.75 ± 0.10 (0.069 ± 0.004)	1.75 ± 0.10 (0.069 ± 0.004)
E ₂ min.	10.25 (0.404)	10.25 (0.404)	10.25 (0.404)
T max.	0.6 (0.024)	0.6 (0.024)	0.6 (0.024)
T ₁ max.	0.1 (0.004)	0.1 (0.004)	0.1 (0.004)
K ₀	1.30 ± 0.10 (0.051 ± 0.004)	0.95 ± 0.10 (0.037 ± 0.004)	1.50 ± 0.10 (0.059 ± 0.004)
Leader min.	390 (15.35)	390 (15.35)	390 (15.35)
Trailer min.	160 (6.30)	160 (6.30)	160 (6.30)
Reel Dimensions			
A max.	185 (7.28)	185 (7.28)	185 (7.28)
N min.	50 (1.97)	50 (1.97)	50 (1.97)
W ₁	$12.4 + 2.0/-0.0$ (0.488 + 0.079/-0.0)	$12.4 + 2.0/-0.0$ (0.488 + 0.079/-0.0)	$12.4 + 2.0/-0.0$ (0.488 + 0.079/-0.0)
W ₂ max.	18.4 (0.724)	18.4 (0.724)	18.4 (0.724)

DIMENSIONS: $\frac{\text{MM}}{(\text{INCHES})}$



Specifications are subject to change without notice.
Customers should verify actual device performance in their specific applications